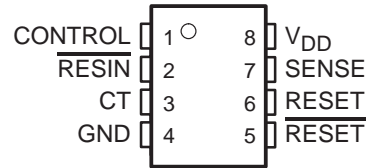


# TLC7701, TLC7725, TLC7703, TLC7733, TLC7705 MICROPOWER SUPPLY VOLTAGE SUPERVISORS

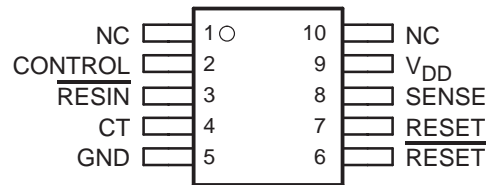
SLVS087L – DECEMBER 1994 – REVISED FEBRUARY 2003

- Power-On Reset Generator
- Automatic Reset Generation After Voltage Drop
- Precision Voltage Sensor
- Temperature-Compensated Voltage Reference
- Programmable Delay Time by External Capacitor
- Supply Voltage Range . . . 2 V to 6 V
- Defined  $\overline{\text{RESET}}$  Output from  $V_{\text{DD}} \geq 1 \text{ V}$
- Power-Down Control Support for Static RAM With Battery Backup
- Maximum Supply Current of 16  $\mu\text{A}$
- Power Saving Totem-Pole Outputs
- Temperature Range . . . Up to  $-55^\circ\text{C}$  to  $125^\circ\text{C}$

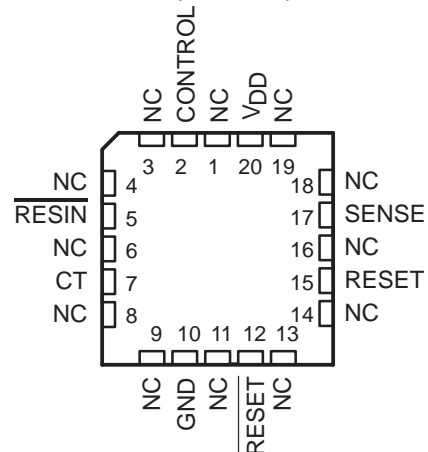
D, JG, P OR PW PACKAGE  
(TOP VIEW)



U PACKAGE  
(TOP VIEW)



FK PACKAGE  
(TOP VIEW)



## description

The TLC77xx family of micropower supply voltage supervisors provide reset control, primarily in microcomputer and microprocessor systems.

During power-on,  $\overline{\text{RESET}}$  is asserted when  $V_{\text{DD}}$  reaches 1 V. After minimum  $V_{\text{DD}} (\geq 2 \text{ V})$  is established, the circuit monitors SENSE voltage and keeps the reset outputs active as long as SENSE voltage ( $V_{\text{I(SENSE)}}$ ) remains below the threshold voltage. An internal timer delays return of the output to the inactive state to ensure proper system reset. The delay time,  $t_{\text{d}}$ , is determined by an external capacitor:

$$t_{\text{d}} = 2.1 \times 10^4 \times C_{\text{T}}$$

Where

$C_{\text{T}}$  is in farads

$t_{\text{d}}$  is in seconds

Except for the TLC7701, which can be customized with two external resistors, each supervisor has a fixed SENSE threshold voltage set by an internal voltage divider. When SENSE voltage drops below the threshold voltage, the outputs become active and stay in that state until SENSE voltage returns above threshold voltage and the delay time,  $t_{\text{d}}$ , has expired.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

 **TEXAS  
INSTRUMENTS**

POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

Copyright © 1994 – 2003, Texas Instruments Incorporated

# TLC7701, TLC7725, TLC7703, TLC7733, TLC7705 MICROPOWER SUPPLY VOLTAGE SUPERVISORS

SLVS087L – DECEMBER 1994 – REVISED FEBRUARY 2003

## description (continued)

In addition to the power-on-reset and undervoltage-supervisor function, the TLC77xx adds power-down control support for static RAM. When CONTROL is tied to GND, RESET will act as active high. The voltage monitor contains additional logic intended for control of static memories with battery backup during power failure. By driving the chip select ( $\overline{CS}$ ) of the memory circuit with the RESET output of the TLC77xx and with the CONTROL driven by the memory bank select signal ( $\overline{CSH1}$ ) of the microprocessor (see Figure 10), the memory circuit is automatically disabled during a power loss. (In this application the TLC77xx power has to be supplied by the battery.)

The TLC77xxI is characterized for operation over a temperature range of  $-40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ ; the TLC77xxQ is characterized for operation over a temperature range of  $-40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ ; and the TLC77xxM is characterized for operation over the full Military temperature range of  $-55^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ .

### AVAILABLE OPTIONS

| T <sub>A</sub>                                 | THRESHOLD VOLTAGE (V) | PACKAGED DEVICES               |                   |                  |                           |                 |   |
|--|-----------------------|--------------------------------|-------------------|------------------|---------------------------|-----------------|---|
|  |                       | SMALL OUTLINE (D) <sup>†</sup> | CHIP CARRIER (FK) | CERAMIC DIP (JG) | CERAMIC DUAL FLATPACK (U) | PLASTIC DIP (P) | THIN SHRINK SMALL OUTLINE (PW) <sup>‡</sup> |
| $-40^{\circ}\text{C}$ to $85^{\circ}\text{C}$  | 1.1                   | TLC7701ID                      | —                 | —                | —                         | TLC7701IP       | TLC7701IPWR                                 |
|  | 2.25                  | TLC7725ID                      | —                 | —                | —                         | TLC7725IP       | TLC7725IPWR                                 |
|  | 2.63                  | TLC7703ID                      | —                 | —                | —                         | TLC7703IP       | TLC7703IPWR                                 |
|  | 2.93                  | TLC7733ID                      | —                 | —                | —                         | TLC7733IP       | TLC7733IPWR                                 |
|  | 4.55                  | TLC7705ID                      | —                 | —                | —                         | TLC7705IP       | TLC7705IPWR                                 |
| $-40^{\circ}\text{C}$ to $125^{\circ}\text{C}$ | 1.1                   | TLC7701QD                      | —                 | —                | —                         | TLC7701QP       | TLC7701QPWR                                 |
|  | 2.25                  | TLC7725QD                      | —                 | —                | —                         | TLC7725QP       | TLC7725QPWR                                 |
|  | 2.63                  | TLC7703QD                      | —                 | —                | —                         | TLC7703QP       | TLC7703QPWR                                 |
|  | 2.93                  | TLC7733QD                      | —                 | —                | —                         | TLC7733QP       | TLC7733QPWR                                 |
|  | 4.55                  | TLC7705QD                      | —                 | —                | —                         | TLC7705QP       | TLC7705QPWR                                 |
| $-55^{\circ}\text{C}$ to $125^{\circ}\text{C}$ | 2.93                  | —                              | TLC7733MFK        | TLC7733MJG       | —                         | —               | —   |
|  | 4.55                  | —                              | TLC7705MFK        | TLC7705MJG       | TLC7705MU                 | —               | —   |

<sup>†</sup> The D package is available taped and reeled. Add the suffix R to the device type when ordering (e.g., TLC7705QDR).

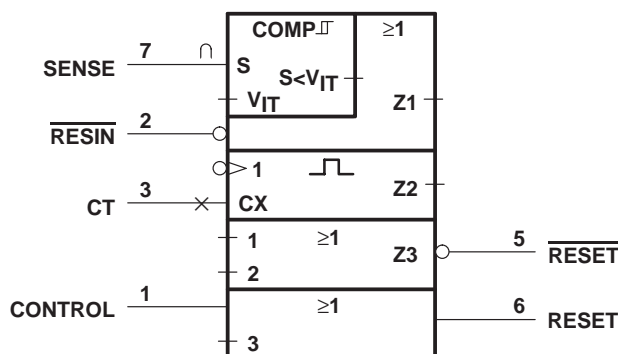
<sup>‡</sup> The PW package is only available left-end taped and reeled (indicated by the R suffix on the device type; e.g., TLC7705QPWR).

### FUNCTION TABLE

| CONTROL | $\overline{RESIN}$ | $V_I(\text{SENSE}) > V_{IT+}$ | RESET          | $\overline{RESET}$ |
|---------|--------------------|-------------------------------|----------------|--------------------|
| L       | L                  | False                         | H              | L                  |
| L       | L                  | True                          | H              | L                  |
| L       | H                  | False                         | H              | L                  |
| L       | H                  | True                          | L <sup>§</sup> | H <sup>§</sup>     |
| H       | L                  | False                         | H              | L                  |
| H       | L                  | True                          | H              | L                  |
| H       | H                  | False                         | H              | L                  |
| H       | H                  | True                          | H              | H <sup>§</sup>     |

<sup>§</sup>  $\overline{RESET}$  and RESET states shown are valid for  $t > t_d$ .

### logic symbol<sup>¶</sup>

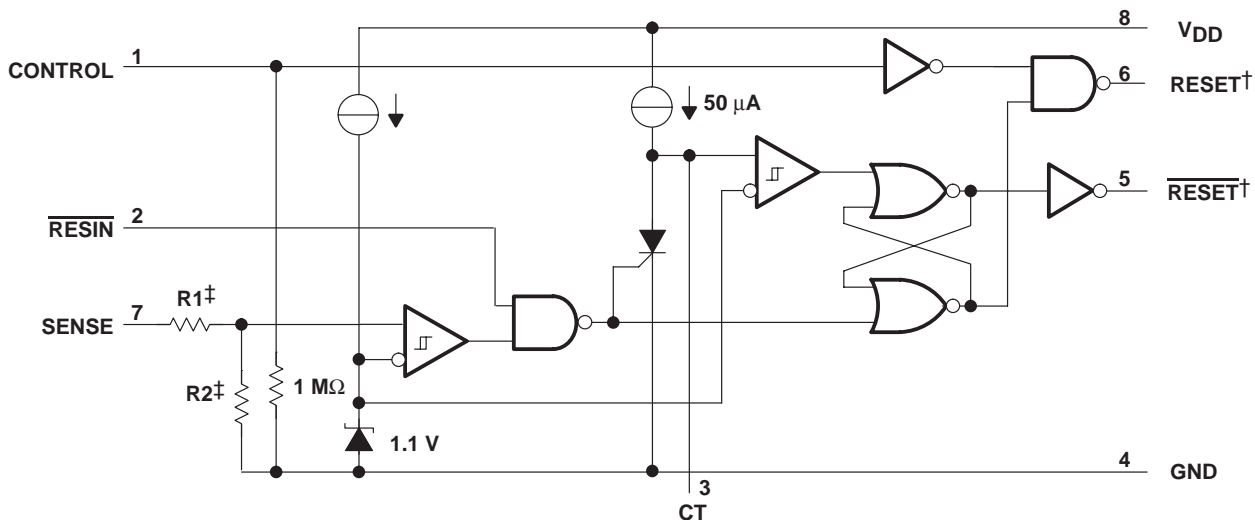


<sup>¶</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

# TLC7701, TLC7725, TLC7703, TLC7733, TLC7705 MICROPOWER SUPPLY VOLTAGE SUPERVISORS

SLVS087L – DECEMBER 1994 – REVISED FEBRUARY 2003

## functional block diagram

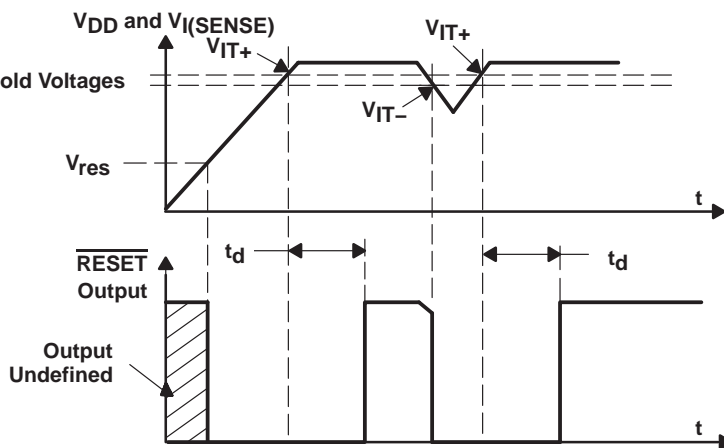


† Outputs are totem-pole configuration. External pullup or pulldown resistors are not required.

‡ Nominal values:

|         | R1 (Typ)       | R2 (Typ)       |
|---------|----------------|----------------|
| TLC7701 | 0              | $\infty$       |
| TLC7725 | 600 k $\Omega$ | 600 k $\Omega$ |
| TLC7703 | 698 k $\Omega$ | 502 k $\Omega$ |
| TLC7733 | 750 k $\Omega$ | 450 k $\Omega$ |
| TLC7705 | 910 k $\Omega$ | 290 k $\Omega$ |

## timing diagram





# TLC7701, TLC7725, TLC7703, TLC7733, TLC7705 MICROPOWER SUPPLY VOLTAGE SUPERVISORS

SLVS087L – DECEMBER 1994 – REVISED FEBRUARY 2003

electrical characteristics over recommended operating conditions (see Note 2) (unless otherwise noted)

| PARAMETER          |  | TEST CONDITIONS   | TLC77xx                                 |      |      | UNIT |    |
|--------------------|--|---|---|------|------|------|----|
|                    |  |   | MIN                                     | TYP† | MAX  |      |    |
| V <sub>OH</sub>    | High-level output voltage                                  | I <sub>OH</sub> = -20 µA  | V <sub>DD</sub> = 2 V                   | 1.8  |      | V    |    |
|                    |  |   | V <sub>DD</sub> = 2.7 V                 | 2.5  |      |      |    |
|                    |  |   | V <sub>DD</sub> = 4.5 V                 | 4.3  |      |      |    |
|                    |  | I <sub>OH</sub> = -2 mA   | V <sub>DD</sub> = 4.5 V                 | 3.7  |      |      |    |
| V <sub>OL</sub>    | Low-level output voltage                                   | I <sub>OL</sub> = 20 µA   | V <sub>DD</sub> = 2 V                   | 0.2  |      | V    |    |
|                    |  |   | V <sub>DD</sub> = 2.7 V                 | 0.2  |      |      |    |
|                    |  |   | V <sub>DD</sub> = 4.5 V                 | 0.2  |      |      |    |
|                    |  | I <sub>OL</sub> = 2 mA  | V <sub>DD</sub> = 4.5 V                 | 0.5  |      |      |    |
| V <sub>IT-</sub>   | Negative-going input threshold voltage, SENSE (see Note 3) | TLC7701   | V <sub>DD</sub> = 2 V to 6 V            | 1.04 | 1.1  | 1.16 | V  |
|                    |  | TLC7725   |   | 2.18 | 2.25 | 2.32 |    |
|                    |  | TLC7703   |   | 2.56 | 2.63 | 2.70 |    |
|                    |  | TLC7733   |   | 2.86 | 2.93 | 3    |    |
|                    |  | TLC7705   |   | 4.47 | 4.55 | 4.63 |    |
| V <sub>hys</sub>   | Hysteresis voltage, SENSE                                  | TLC7701   | V <sub>DD</sub> = 2 V to 6 V            | 30   |      | mV   |    |
|                    |  | TLC7725   | V <sub>DD</sub> = 2 V to 6 V            | 70   |      | mV   |    |
|                    |  | TLC7703,  |   |      |      |      |    |
|                    |  | TLC7733,  |   |      |      |      |    |
|                    |  | TLC7705   |   |      |      |      |    |
| V <sub>res</sub>   | Power-up reset voltage‡                                    | I <sub>OL</sub> = 20 µA   |   |      | 1    | V    |    |
| I <sub>I</sub>     | Input current  | RESIN   | V <sub>I</sub> = 0 V to V <sub>DD</sub> |      |      | 2    | µA |
|                    |  | CONTROL   | V <sub>I</sub> = V <sub>DD</sub>        | 7    |      | 15   |    |
|                    |  | SENSE   | V <sub>I</sub> = 5 V                    | 5    |      | 10   |    |
|                    |  | SENSE, TLC7701 only   | V <sub>I</sub> = 5 V                    |      |      | 2    |    |
| I <sub>DD</sub>    | Supply current   | RESIN = V <sub>DD</sub> ,<br>SENSE = V <sub>DD</sub> ≥ V <sub>ITmax</sub> + 0.2 V<br>CONTROL = 0 V, Outputs open                  |   | 9    |      | 16   | µA |
| I <sub>DD(d)</sub> | Supply current during t <sub>d</sub>                       | V <sub>DD</sub> = 5 V, V <sub>CT</sub> = 0,<br>RESIN = V <sub>DD</sub> , SENSE = V <sub>DD</sub> ,<br>CONTROL = 0 V, Outputs open |   | 120  |      | 150  | µA |
| C <sub>I</sub>     | Input capacitance, SENSE                                   | V <sub>I</sub> = 0 V to V <sub>DD</sub>   |   | 50   |      |      | pF |

† Typical values apply at T<sub>A</sub> = 25°C.

‡ The lowest supply voltage at which RESET becomes active. The symbol V<sub>RES</sub> is not currently listed within EIA or JEDEC standards for semiconductor symbology. Rise time of V<sub>DD</sub> ≥ 15 µs/V.

NOTES: 2. All characteristics are measured with C<sub>T</sub> = 0.1 µF.

3. To ensure best stability of the threshold voltage, a bypass capacitor (ceramic, 0.1 µF) should be connected near the supply terminals.



# TLC7701, TLC7725, TLC7703, TLC7733, TLC7705 MICROPOWER SUPPLY VOLTAGE SUPERVISORS

SLVS087L – DECEMBER 1994 – REVISED FEBRUARY 2003

electrical characteristics over recommended operating conditions (see Note 2) (unless otherwise noted)

| PARAMETER               |  | TEST CONDITIONS  |  | TLC77xxM                        |                                 |     | UNIT |  |
|-------------------------|--|--|--|---------------------------------|---------------------------------|-----|------|--|
|                         |  |  |  | MIN                             | TYP†                            | MAX |      |  |
| V <sub>OH</sub>         | High-level output voltage                                  | I <sub>OH</sub> = -20 μA   | V <sub>DD</sub> = 2 V,   | T <sub>A</sub> = 25°C           | 1.8                             |     | V    |  |
|                         |  |  |  | T <sub>A</sub> = -55°C to 125°C | 1.7                             |     |      |  |
|                         |  |  | V <sub>DD</sub> = 2.7 V  | T <sub>A</sub> = 25°C           | 2.5                             |     |      |  |
|                         |  |  |  | T <sub>A</sub> = -55°C to 125°C | 2.3                             |     |      |  |
|                         |  |  | V <sub>DD</sub> = 4.5 V  | T <sub>A</sub> = 25°C           | 4.3                             |     |      |  |
|                         |  |  |  | T <sub>A</sub> = -55°C to 125°C | 4.2                             |     |      |  |
| I <sub>OH</sub> = -2 mA | V <sub>DD</sub> = 4.5 V                                    | T <sub>A</sub> = 25°C  | 3.7  |                                 |                                 |     |      |  |
|                         |  | T <sub>A</sub> = -55°C to 125°C  | 3.6  |                                 |                                 |     |      |  |
| V <sub>OL</sub>         | Low-level output voltage                                   | I <sub>OL</sub> = 20 μA  | V <sub>DD</sub> = 2 V  | T <sub>A</sub> = 25°C           | 0.2                             |     | V    |  |
|                         |  |  |  | T <sub>A</sub> = -55°C to 125°C | 0.2                             |     |      |  |
|                         |  |  | V <sub>DD</sub> = 2.7 V  | T <sub>A</sub> = 25°C           | 0.2                             |     |      |  |
|                         |  |  |  | T <sub>A</sub> = -55°C to 125°C | 0.2                             |     |      |  |
|                         |  |  | V <sub>DD</sub> = 4.5 V  | T <sub>A</sub> = 25°C           | 0.2                             |     |      |  |
|                         |  |  |  | T <sub>A</sub> = -55°C to 125°C | 0.2                             |     |      |  |
|                         |  |  | I <sub>OL</sub> = 2 mA   | V <sub>DD</sub> = 4.5 V         | T <sub>A</sub> = 25°C           | 0.5 |      |  |
|                         |  |  |  |                                 | T <sub>A</sub> = -55°C to 125°C | 0.5 |      |  |
| V <sub>IT-</sub>        | Negative-going input threshold voltage, SENSE (see Note 3) | TLC7733  | V <sub>DD</sub> = 2 V to 6 V   | 2.86                            | 2.93                            | 3.1 | V    |  |
|                         |  | TLC7705  |  | 4.3                             | 4.5                             | 4.8 |      |  |
| V <sub>hys</sub>        | Hysteresis voltage, SENSE                                  | V <sub>DD</sub> = 2 V to 6 V   | V <sub>DD</sub> = 2 V to 6 V   | 70                              |                                 | mV  |      |  |
| V <sub>res</sub>        | Power-up reset voltage‡                                    | I <sub>OL</sub> = 20 μA  |  | 1                               |                                 | V   |      |  |
| I <sub>I</sub>          | Input current  | RESIN  | V <sub>I</sub> = 0 V to V <sub>DD</sub>  | 2                               |                                 | μA  |      |  |
|                         |  | CONTROL  | V <sub>I</sub> = V <sub>DD</sub>   | 7                               | 15                              |     |      |  |
|                         |  | SENSE  | V <sub>I</sub> = 5 V   | 5                               | 10                              |     |      |  |
|                         |  | SENSE, TLC7701 only  | V <sub>I</sub> = 5 V   | 2                               |                                 |     |      |  |
| I <sub>DD</sub>         | Supply current   | RESIN = V <sub>DD</sub> ,<br>SENSE = V <sub>DD</sub> ≥ V <sub>ITmax</sub> + 0.2 V<br>CONTROL = 0 V, Outputs open |  | 9                               | 16                              | μA  |      |  |
| I <sub>DD(d)</sub>      | Supply current during t <sub>d</sub>                       | TLC7733  | V <sub>CT</sub> = 0,<br>RESIN = V <sub>DD</sub> ,<br>CONTROL = 0 V,<br>SENSE = V <sub>DD</sub> ,<br>Outputs open | 250                             |                                 | μA  |      |  |
|                         |  | TLC7705  | V <sub>DD</sub> = 3.3 V  |                                 |                                 |     |      |  |
|                         |  |  | V <sub>DD</sub> = 5 V  | 120                             | 150                             |     |      |  |
| C <sub>I</sub>          | Input capacitance, SENSE                                   | V <sub>I</sub> = 0 V to V <sub>DD</sub>  |  | 50                              |                                 | pF  |      |  |

† Typical values apply at T<sub>A</sub> = 25°C.

‡ The lowest supply voltage at which RESET becomes active. The symbol V<sub>res</sub> is not currently listed within EIA or JEDEC standards for semiconductor symbology. Rise time of V<sub>DD</sub> ≥ 15 μs/V.

NOTES: 2. All characteristics are measured with C<sub>T</sub> = 0.1 μF.

3. To ensure best stability of the threshold voltage, a bypass capacitor (ceramic, 0.1 μF) should be placed near the supply terminals.



# TLC7701, TLC7725, TLC7703, TLC7733, TLC7705 MICROPOWER SUPPLY VOLTAGE SUPERVISORS

SLVS087L – DECEMBER 1994 – REVISED FEBRUARY 2003

switching characteristics at  $V_{DD} = 5\text{ V}$ ,  $R_L = 2\text{ k}\Omega$ ,  $C_L = 50\text{ pF}$ ,  $T_A = 25^\circ\text{C}$  (unless otherwise noted)

| PARAMETER  | MEASURED                           |                           | TEST CONDITIONS  | TLC77xx |     |     | UNIT          |
|--|------------------------------------|---------------------------|--|---------|-----|-----|---------------|
|  | FROM (INPUT)                       | TO (OUTPUT)               |  | MIN     | TYP | MAX |               |
| $t_d$ Delay time   | $V_{I(\text{SENSE})} \geq V_{IT+}$ | RESET and RESET           | $\overline{\text{RESIN}} = 0.7 \times V_{DD}$ ,<br>CONTROL = $0.2 \times V_{DD}$ ,<br>$C_T = 100\text{ nF}$ ,<br>$T_A = \text{Full range}$ ,<br>See timing diagram                             | 1.1     | 2.1 | 4.2 | ms            |
| $t_{PLH}$ Propagation delay time, low-to-high-level output | SENSE                              | $\overline{\text{RESET}}$ | $V_{IH} = V_{IT+max} + 0.2\text{ V}$ ,<br>$V_{IL} = V_{IT\_min} - 0.2\text{ V}$ ,<br>$\overline{\text{RESIN}} = 0.7 \times V_{DD}$ ,<br>CONTROL = $0.2 \times V_{DD}$ ,<br>$C_T = NCT^\dagger$ |         |     | 20  | $\mu\text{s}$ |
| $t_{PHL}$ Propagation delay time, high-to-low-level output |                                    | $\overline{\text{RESET}}$ |  |         |     | 5   |               |
| $t_{PLH}$ Propagation delay time, low-to-high-level output |                                    | RESET                     |  |         |     | 5   |               |
| $t_{PHL}$ Propagation delay time, high-to-low-level output |                                    | RESET                     |  |         |     | 20  |               |
| $t_{PLH}$ Propagation delay time, low-to-high-level output | $\overline{\text{RESIN}}$          | $\overline{\text{RESET}}$ | $V_{IH} = 0.7 \times V_{DD}$ ,<br>$V_{IL} = 0.2 \times V_{DD}$ ,<br>SENSE = $V_{IT+max} + 0.2\text{ V}$ ,<br>CONTROL = $0.2 \times V_{DD}$ ,<br>$C_T = NCT^\dagger$                            |         |     | 20  | $\mu\text{s}$ |
| $t_{PHL}$ Propagation delay time, high-to-low-level output |                                    | $\overline{\text{RESET}}$ |  |         |     | 40  |               |
| $t_{PLH}$ Propagation delay time, low-to-high-level output |                                    | RESET                     |  |         |     |     | 45            |
| $t_{PHL}$ Propagation delay time, high-to-low-level output |                                    | RESET                     |  |         |     |     |               |
| $t_{PLH}$ Propagation delay time, low-to-high-level output | CONTROL                            | RESET                     | $V_{IH} = 0.7 \times V_{DD}$ ,<br>$V_{IL} = 0.2 \times V_{DD}$ ,<br>SENSE = $V_{IT+max} + 0.2\text{ V}$ ,<br>$\overline{\text{RESIN}} = 0.7 \times V_{DD}$ ,<br>$C_T = NCT^\dagger$            |         |     | 38  | ns            |
| $t_{PHL}$ Propagation delay time, high-to-low-level output |                                    |                           |  |         |     |     |               |
| Low-level minimum pulse duration to switch RESET and RESET | SENSE                              |                           | $V_{IH} = V_{IT+max} + 0.2\text{ V}$ ,<br>$V_{IL} = V_{IT\_min} - 0.2\text{ V}$ ,  | 3       |     |     | $\mu\text{s}$ |
|  | $\overline{\text{RESIN}}$          |                           | $V_{IL} = 0.2 \times V_{DD}$ ,<br>$V_{IH} = 0.7 \times V_{DD}$   | 1       |     |     |               |
| $t_r$ Rise time  |                                    | RESET and RESET           | 10% to 90%   |         | 8   |     | ns/V          |
| $t_f$ Fall time  |                                    | RESET and RESET           | 90% to 10%   |         | 4   |     |               |

$^\dagger$  NC = No capacitor, and includes up to 100-pF probe and jig capacitance.

# TLC7701, TLC7725, TLC7703, TLC7733, TLC7705 MICROPOWER SUPPLY VOLTAGE SUPERVISORS

SLVS087L – DECEMBER 1994 – REVISED FEBRUARY 2003

switching characteristics at  $V_{DD} = 5\text{ V}$ ,  $R_L = 2\text{ k}\Omega$ ,  $C_L = 50\text{ pF}$

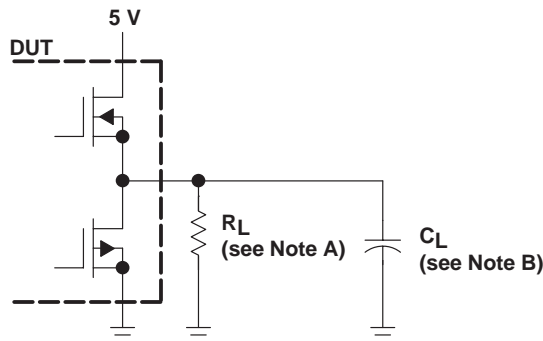
| PARAMETER  | MEASURED                         |                 | TEST CONDITIONS   | $T_A$      | TLC77xxM |  |            | UNIT          |  |    |               |
|--|----------------------------------|-----------------|---|------------|----------|--|------------|---------------|--|----|---------------|
|  | FROM (INPUT)                     | TO (OUTPUT)     |   |            | MIN      | TYP  | MAX        |               |  |    |               |
| $t_d$ Delay time   | $V_I(\text{SENSE}) \geq V_{IT+}$ | RESET and RESET | RESIN = 2.7 V,<br>CONTROL = 0.4 V,<br>$C_T = 100\text{ nF}$ ,<br>See timing diagram   | Full range | 1.1      | 2.1  | 4.2        | ms            |  |    |               |
| $t_{PLH}$ Propagation delay time, low-to-high-level output | SENSE                            | RESET           | $V_{IH} = V_{IT+max} + 0.2\text{ V}$ ,<br>$V_{IL} = V_{IT-min} - 0.2\text{ V}$ ,<br>RESIN = 2.7 V,<br>CONTROL = 0.4 V,<br>$C_T = \text{NC}^\dagger$ | 25°C       |          |  | 20         | $\mu\text{s}$ |  |    |               |
|  |                                  | Full range      |   |            |          | 24   |            |               |  |    |               |
|  |                                  | RESET           |   | 25°C       |          |  | 5          | $\mu\text{s}$ |  |    |               |
|  |                                  | Full range      |   |            |          | 7  |            |               |  |    |               |
| $t_{PHL}$ Propagation delay time, high-to-low-level output | SENSE                            | RESET           | $V_{IH} = V_{IT+max} + 0.2\text{ V}$ ,<br>$V_{IL} = V_{IT-min} - 0.2\text{ V}$ ,<br>RESIN = 2.7 V,<br>CONTROL = 0.4 V,<br>$C_T = \text{NC}^\dagger$ | 25°C       |          |  | 5          | $\mu\text{s}$ |  |    |               |
|  |                                  | Full range      |   |            |          | 7  |            |               |  |    |               |
|  |                                  | RESET           |   | 25°C       |          |  | 20         | $\mu\text{s}$ |  |    |               |
|  |                                  | Full range      |   |            |          | 24   |            |               |  |    |               |
| $t_{PLH}$ Propagation delay time, low-to-high-level output | RESIN                            | RESET           | $V_{IH} = 2.7\text{ V}$ ,<br>$V_{IL} = 0.4\text{ V}$ ,<br>SENSE = $V_{IT+max} + 0.2\text{ V}$ ,<br>CONTROL = 0.4 V,<br>$C_T = \text{NC}^\dagger$    | 25°C       |          |  | 20         | $\mu\text{s}$ |  |    |               |
|  |                                  | Full range      |   |            |          | 24   |            |               |  |    |               |
|  |                                  | RESET           |   | 25°C       |          |  | 45         | ns            |  |    |               |
|  |                                  | Full range      |   |            |          | 65   |            |               |  |    |               |
| $t_{PHL}$ Propagation delay time, high-to-low-level output | RESIN                            | RESET           | $V_{IH} = 2.7\text{ V}$ ,<br>$V_{IL} = 0.4\text{ V}$ ,<br>SENSE = $V_{IT+max} + 0.2\text{ V}$ ,<br>CONTROL = 0.4 V,<br>$C_T = \text{NC}^\dagger$    | 25°C       |          |  | 40         | ns            |  |    |               |
|  |                                  | Full range      |   |            |          | 60   |            |               |  |    |               |
|  |                                  | RESET           |   | 25°C       |          |  | 20         | $\mu\text{s}$ |  |    |               |
|  |                                  | Full range      |   |            |          | 24   |            |               |  |    |               |
| $t_{PLH}$ Propagation delay time, low-to-high-level output | CONTROL                          | RESET           | $V_{IH} = 2.7\text{ V}$ ,<br>$V_{IL} = 0.4\text{ V}$ ,<br>SENSE = $V_{IT+max} + 0.2\text{ V}$ ,<br>RESIN = 2.7 V,<br>$C_T = \text{NC}^\dagger$      | 25°C       |          |  | 38         | ns            |  |    |               |
|  |                                  |                 |   | Full range |          |  | 58         |               |  |    |               |
| $t_{PHL}$ Propagation delay time, high-to-low-level output |                                  |                 |   | CONTROL    | RESET    | $V_{IH} = 2.7\text{ V}$ ,<br>$V_{IL} = 0.4\text{ V}$ ,<br>SENSE = $V_{IT+max} + 0.2\text{ V}$ ,<br>RESIN = 2.7 V,<br>$C_T = \text{NC}^\dagger$ | 25°C       |               |  | 38 | ns            |
|  |                                  |                 |   |            |          |  | Full range |               |  | 58 |               |
| Low-level minimum pulse duration                           | SENSE                            |                 | $V_{IH} = V_{IT+max} + 0.2\text{ V}$ ,<br>$V_{IL} = V_{IT-min} - 0.2\text{ V}$ ,<br>$V_{IL} = 0.4\text{ V}$ ,<br>$V_{IH} = 2.7\text{ V}$            |            |          |  | Full range | 3             |  |    | $\mu\text{s}$ |
|  | RESIN                            |                 |   |            |          |  |            | 1             |  |    |               |
| $t_r$ Rise time  |                                  | RESET and RESET | 10% to 90%  | Full range | 8        |  |            | ns/V          |  |    |               |
| $t_f$ Fall time  |                                  |                 | 90% to 10%  |            | 4        |  |            |               |  |    |               |

$^\dagger$  NC = No capacitor, and includes up to 100-pF probe and jig capacitance.





PARAMETER MEASUREMENT INFORMATION



NOTES: A. For switching characteristics,  $R_L = 2\text{ k}\Omega$ .  
B.  $C_L = 50\text{ pF}$  includes jig and probe capacitance.

Figure 1. RESET AND  $\overline{\text{RESET}}$  Output Configurations

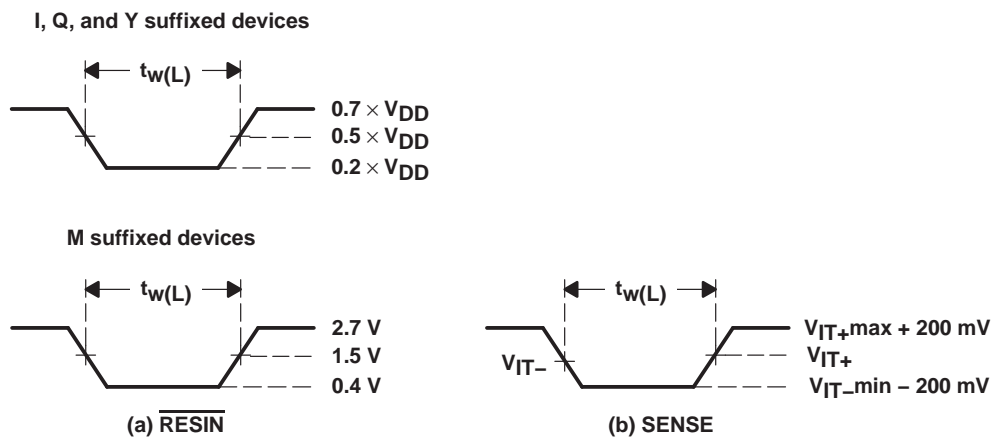


Figure 2. Input Pulse Definition Waveforms

# TLC7701, TLC7725, TLC7703, TLC7733, TLC7705 MICROPOWER SUPPLY VOLTAGE SUPERVISORS

SLVS087L – DECEMBER 1994 – REVISED FEBRUARY 2003

## TYPICAL CHARACTERISTICS

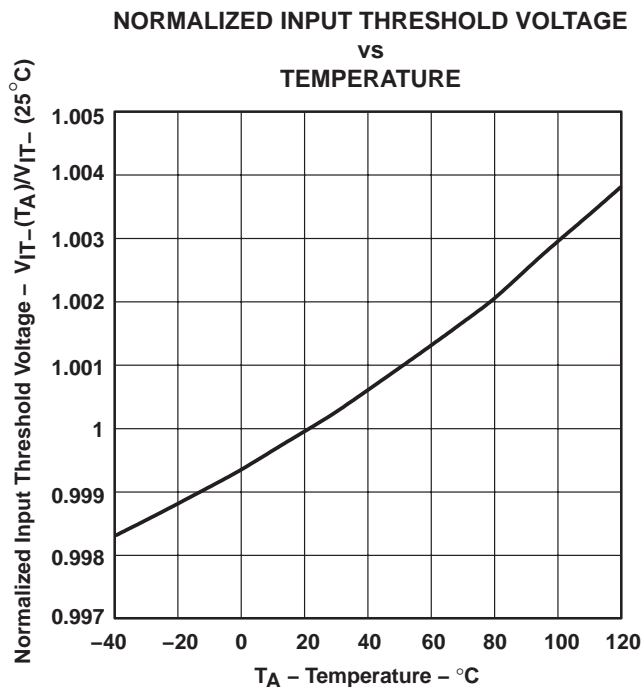


Figure 3

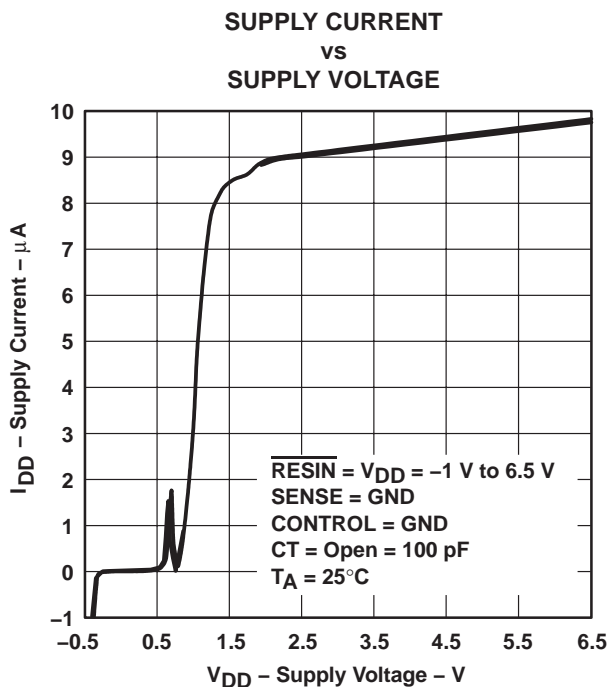


Figure 4

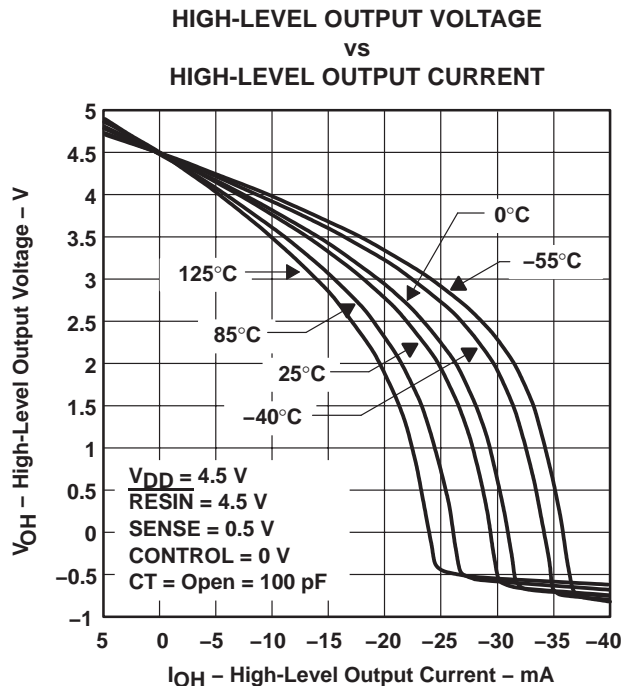


Figure 5

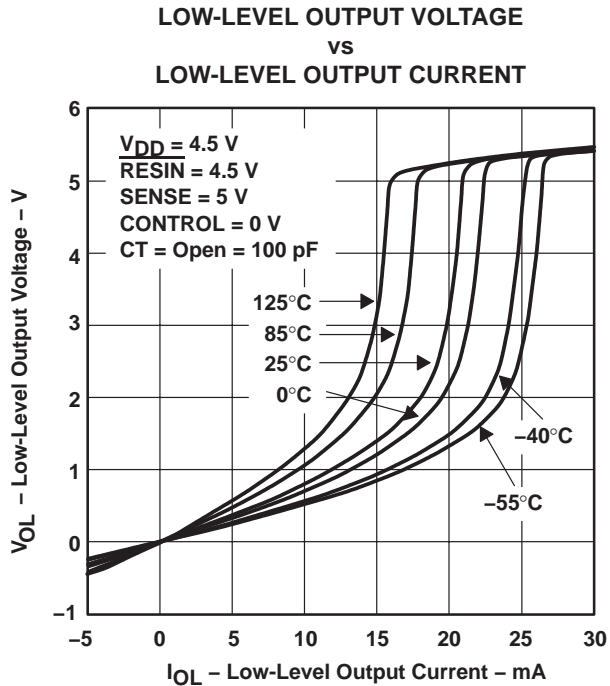
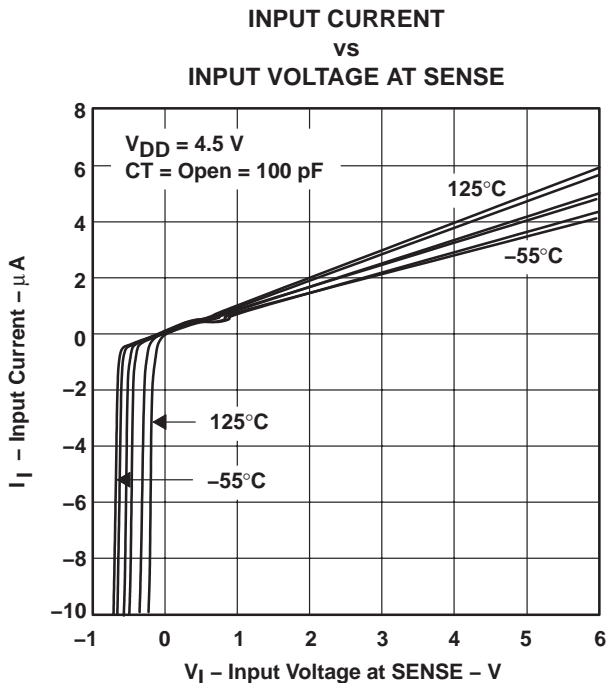


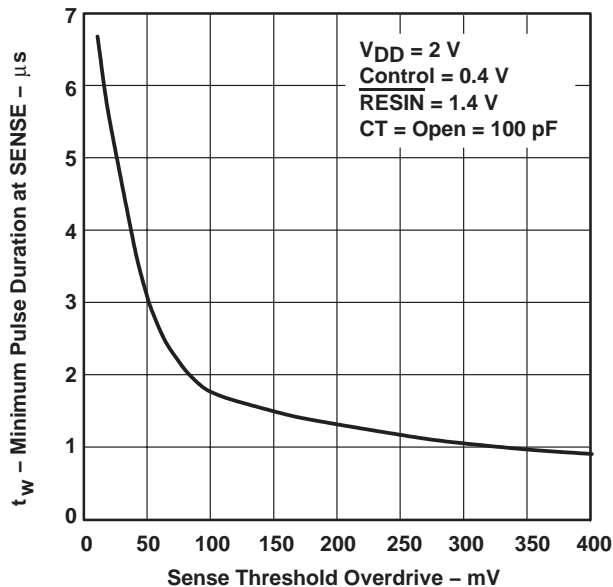
Figure 6



TYPICAL CHARACTERISTICS



MINIMUM PULSE DURATION AT SENSE  
vs  
SENSE THRESHOLD OVERDRIVE



# TLC7701, TLC7725, TLC7703, TLC7733, TLC7705 MICROPOWER SUPPLY VOLTAGE SUPERVISORS

SLVS087L – DECEMBER 1994 – REVISED FEBRUARY 2003

## APPLICATION INFORMATION

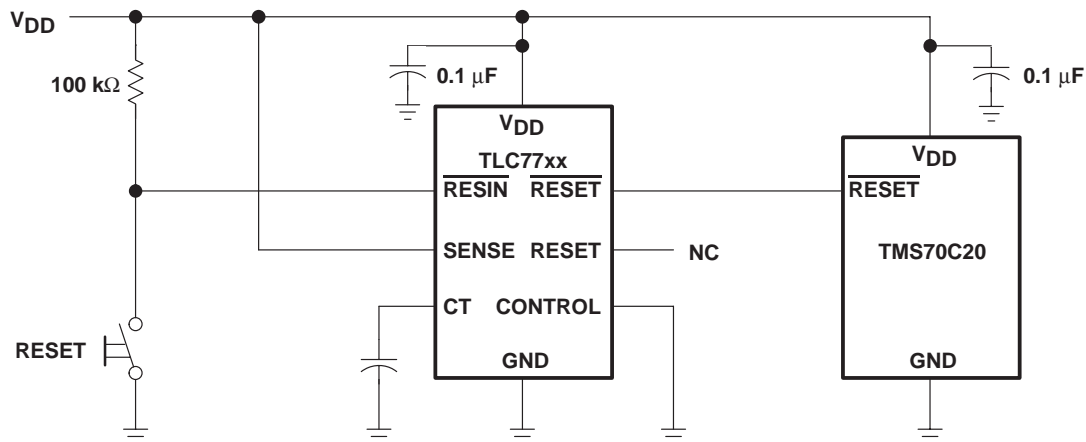


Figure 9. Reset Controller in a Microcomputer System

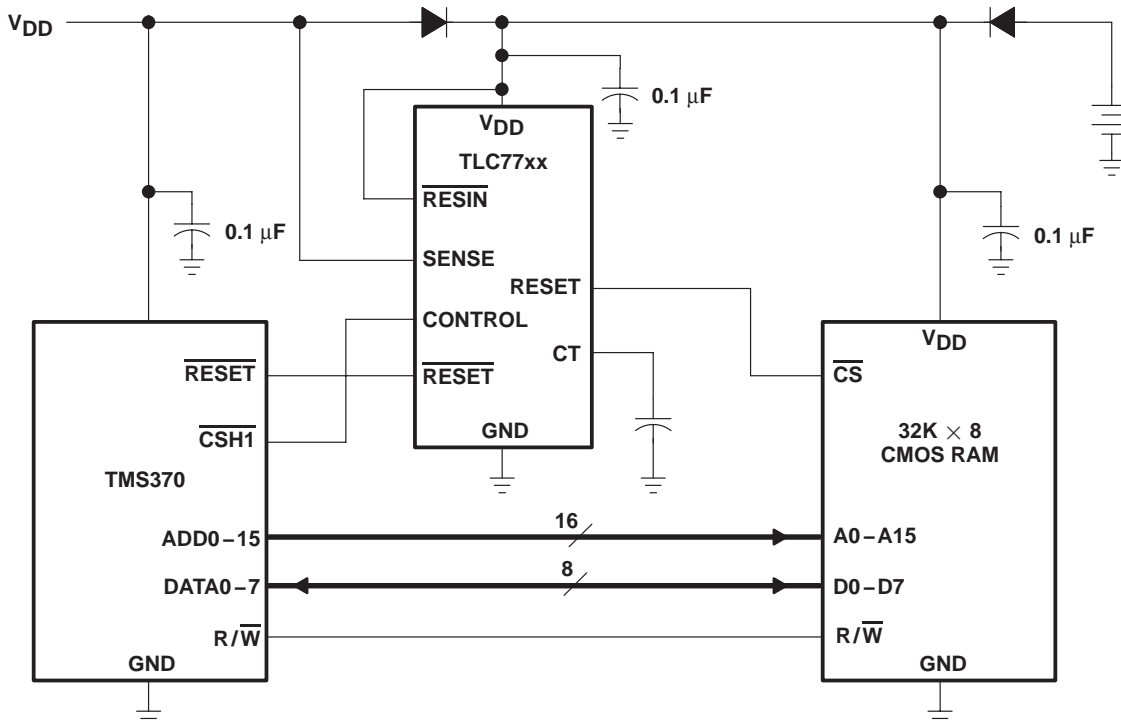


Figure 10. Data Retention During Power Down Using Static CMOS RAMs

# TLC7701, TLC7725, TLC7703, TLC7733, TLC7705 MICROPOWER SUPPLY VOLTAGE SUPERVISORS

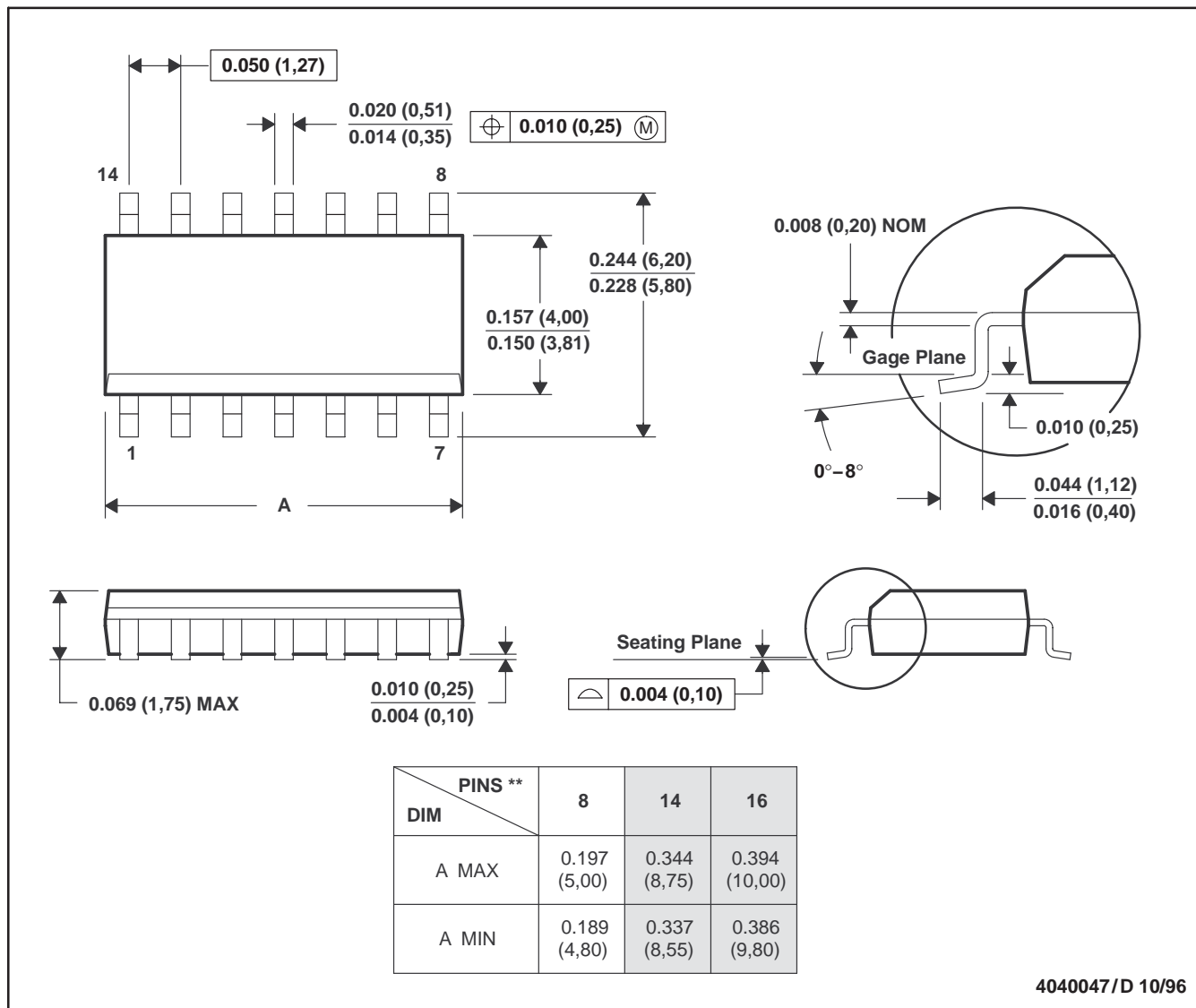
SLVS087L – DECEMBER 1994 – REVISED FEBRUARY 2003

## MECHANICAL DATA

D (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14 PIN SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).  
 D. Falls within JEDEC MS-012

# TLC7701, TLC7725, TLC7703, TLC7733, TLC7705 MICROPOWER SUPPLY VOLTAGE SUPERVISORS

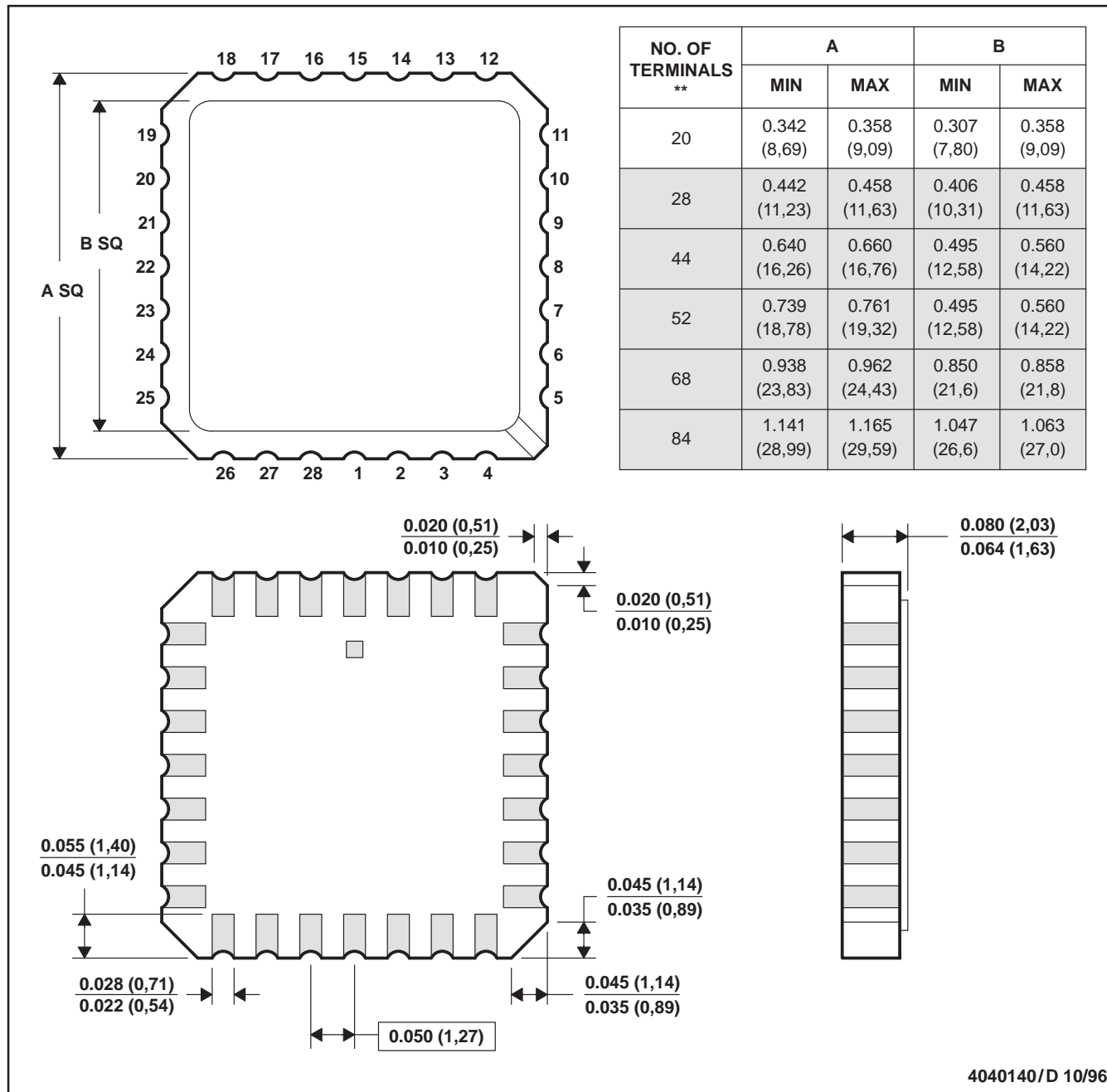
SLVS087L – DECEMBER 1994 – REVISED FEBRUARY 2003

## MECHANICAL DATA

FK (S-CQCC-N\*\*)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. This package can be hermetically sealed with a metal lid.  
 D. The terminals are gold plated.  
 E. Falls within JEDEC MS-004

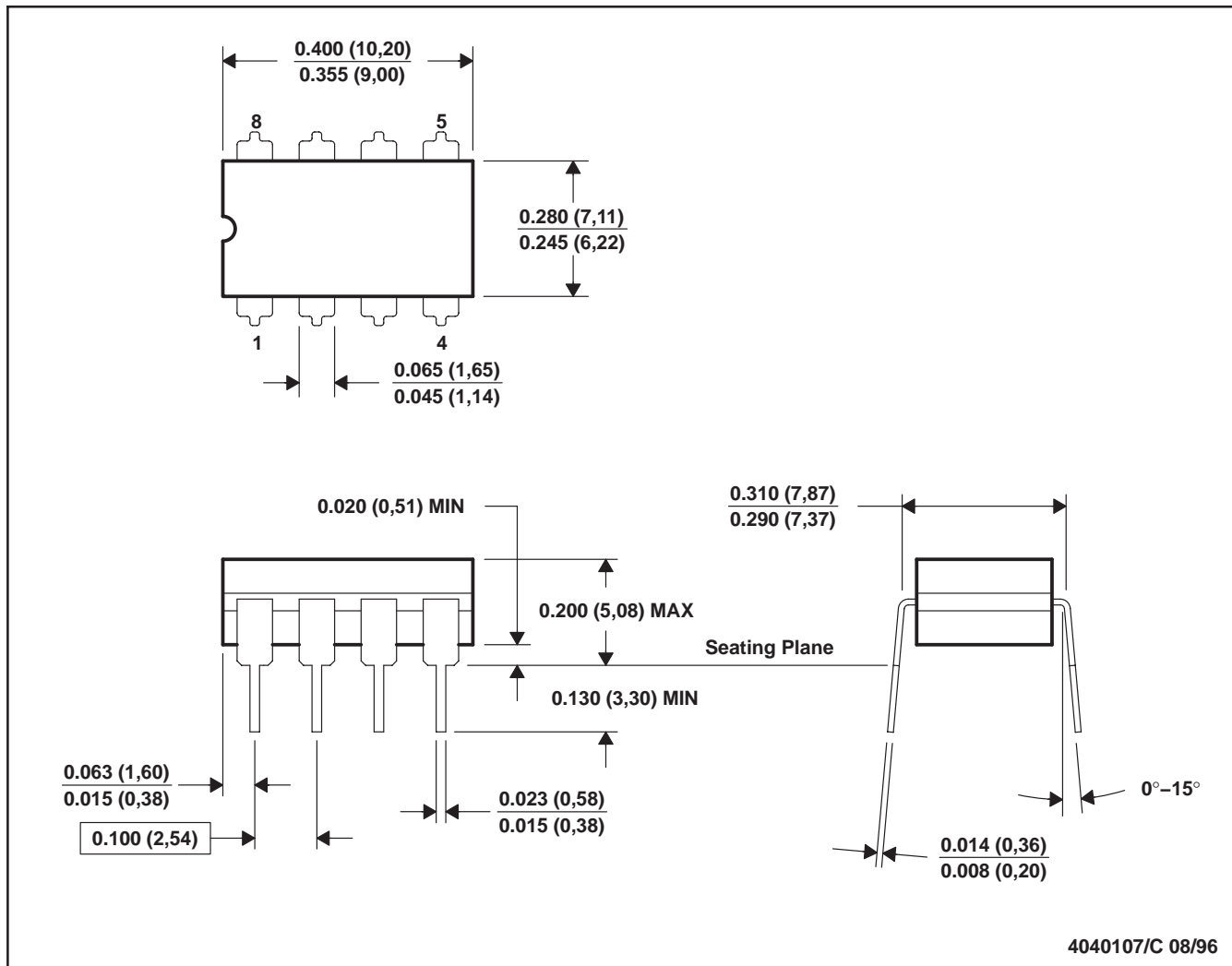
# TLC7701, TLC7725, TLC7703, TLC7733, TLC7705 MICROPOWER SUPPLY VOLTAGE SUPERVISORS

SLVS087L – DECEMBER 1994 – REVISED FEBRUARY 2003

## MECHANICAL DATA

JG (R-GDIP-T8)

CERAMIC DUAL-IN-LINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
  - E. Falls within MIL-STD-1835 GDIP1-T8

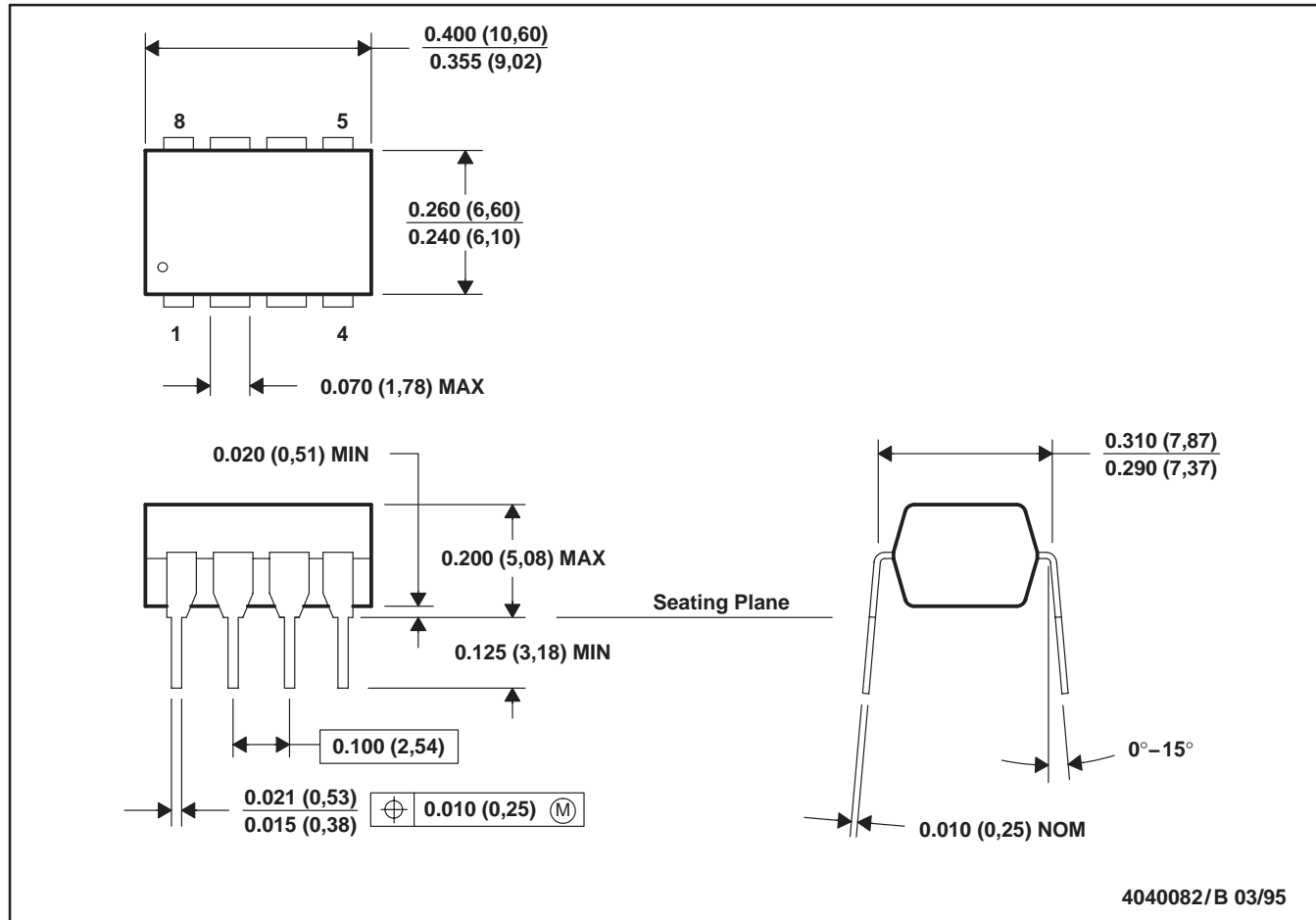
# TLC7701, TLC7725, TLC7703, TLC7733, TLC7705 MICROPOWER SUPPLY VOLTAGE SUPERVISORS

SLVS087L – DECEMBER 1994 – REVISED FEBRUARY 2003

## MECHANICAL DATA

P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE



- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. Falls within JEDEC MS-001



# TLC7701, TLC7725, TLC7703, TLC7733, TLC7705 MICROPOWER SUPPLY VOLTAGE SUPERVISORS

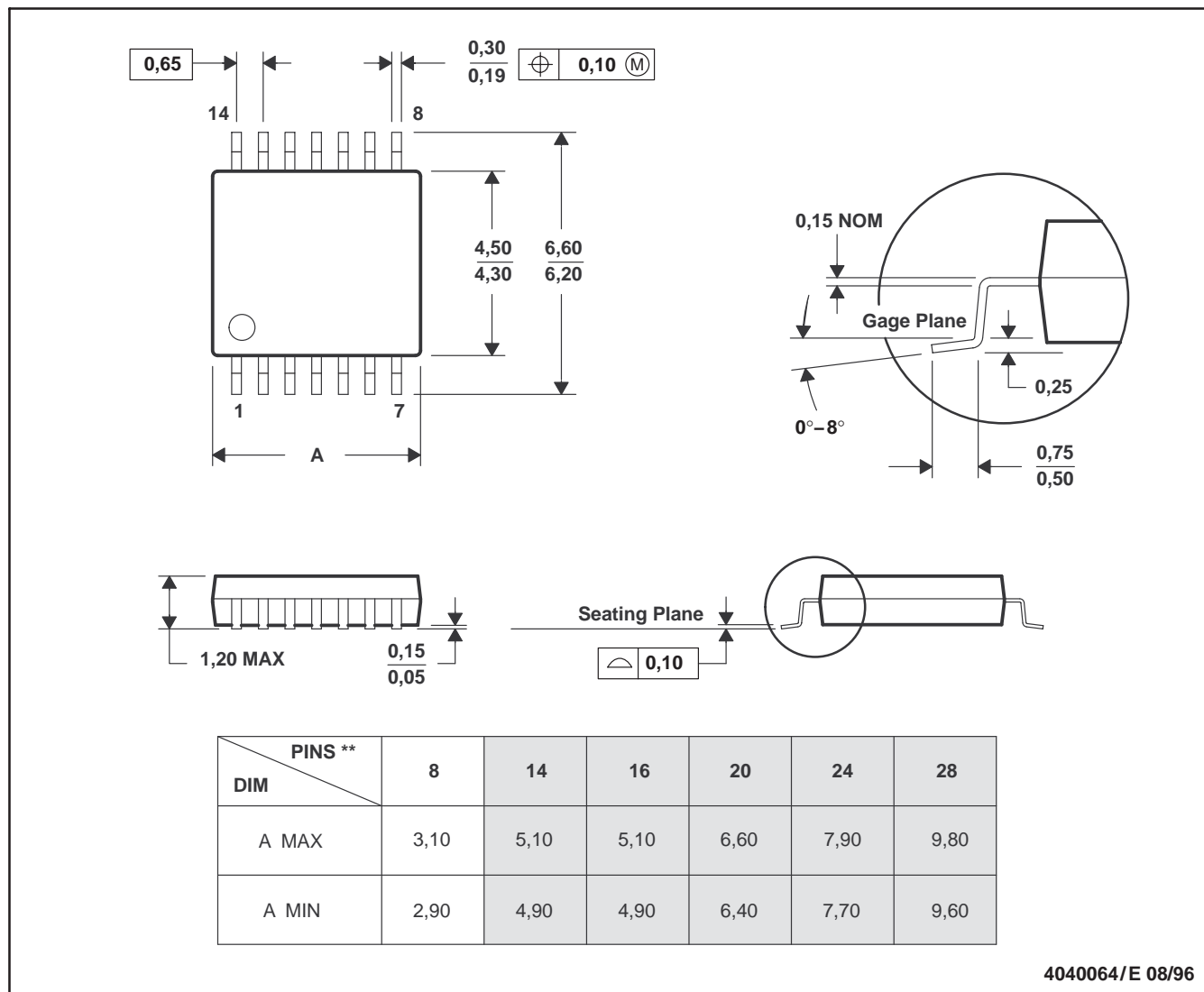
SLVS087L – DECEMBER 1994 – REVISED FEBRUARY 2003

## MECHANICAL DATA

PW (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14 PIN SHOWN



4040064/E 08/96

- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

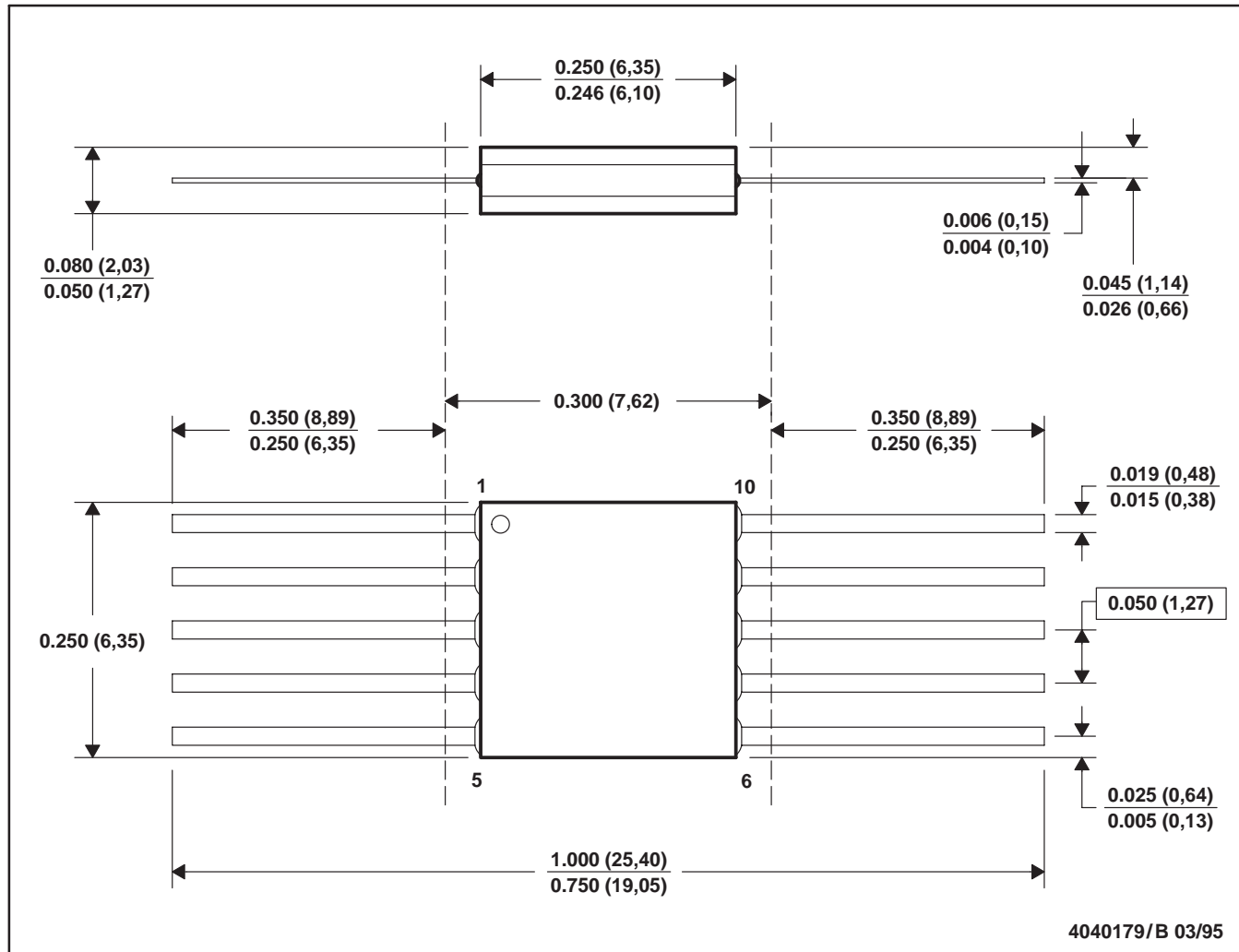
# TLC7701, TLC7725, TLC7703, TLC7733, TLC7705 MICROPOWER SUPPLY VOLTAGE SUPERVISORS

SLVS087L – DECEMBER 1994 – REVISED FEBRUARY 2003

## MECHANICAL DATA

U (S-GDFP-F10)

CERAMIC DUAL FLATPACK



- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. This package can be hermetically sealed with a ceramic lid using glass frit.  
 D. Index point is provided on cap for terminal identification only.  
 E. Falls within MIL STD 1835 GDFP1-F10 and JEDEC MO-092AA

**PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| 5962-9750901Q2A  | ACTIVE                | LCCC         | FK              | 20   | 1           | TBD                     | POST-PLATE       | N / A for Pkg Type           |
| 5962-9750901QPA  | ACTIVE                | CDIP         | JG              | 8    | 1           | TBD                     | A42 SNPB         | N / A for Pkg Type           |
| 5962-9751301Q2A  | ACTIVE                | LCCC         | FK              | 20   | 1           | TBD                     | POST-PLATE       | N / A for Pkg Type           |
| 5962-9751301QHA  | ACTIVE                | CFP          | U               | 10   | 1           | TBD                     | A42 SNPB         | N / A for Pkg Type           |
| 5962-9751301QPA  | ACTIVE                | CDIP         | JG              | 8    | 1           | TBD                     | A42 SNPB         | N / A for Pkg Type           |
| TLC7701ID        | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7701IDG4      | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7701IDR       | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7701IDRG4     | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7701IP        | ACTIVE                | PDIP         | P               | 8    | 50          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| TLC7701IPE4      | ACTIVE                | PDIP         | P               | 8    | 50          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| TLC7701IPW       | ACTIVE                | TSSOP        | PW              | 8    | 150         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7701IPWG4     | ACTIVE                | TSSOP        | PW              | 8    | 150         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7701IPWLE     | OBSOLETE              | TSSOP        | PW              | 8    |             | TBD                     | Call TI          | Call TI                      |
| TLC7701IPWR      | ACTIVE                | TSSOP        | PW              | 8    | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7701IPWRG4    | ACTIVE                | TSSOP        | PW              | 8    | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7701IQD       | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7701IQDG4     | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7701IQDR      | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7701IQDRG4    | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7701IQP       | ACTIVE                | PDIP         | P               | 8    | 50          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| TLC7701IQPE4     | ACTIVE                | PDIP         | P               | 8    | 50          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| TLC7701IQPW      | ACTIVE                | TSSOP        | PW              | 8    | 150         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7701IQPWG4    | ACTIVE                | TSSOP        | PW              | 8    | 150         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7701IQPWLE    | PREVIEW               | TSSOP        | PW              | 8    |             | TBD                     | Call TI          | Call TI                      |
| TLC7701IQPWR     | ACTIVE                | TSSOP        | PW              | 8    | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7701IQPWRG4   | ACTIVE                | TSSOP        | PW              | 8    | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7703ID        | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
|                  |                       |              |                 |      |             | no Sb/Br)               |                  |                              |
| TLC7703IDG4      | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7703IDR       | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7703IDRG4     | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7703IP        | ACTIVE                | PDIP         | P               | 8    | 50          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| TLC7703IPE4      | ACTIVE                | PDIP         | P               | 8    | 50          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| TLC7703IPW       | ACTIVE                | TSSOP        | PW              | 8    | 150         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7703IPWG4     | ACTIVE                | TSSOP        | PW              | 8    | 150         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7703IPWLE     | OBSOLETE              | TSSOP        | PW              | 8    |             | TBD                     | Call TI          | Call TI                      |
| TLC7703IPWR      | ACTIVE                | TSSOP        | PW              | 8    | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7703IPWRG4    | ACTIVE                | TSSOP        | PW              | 8    | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7703QD        | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7703QDG4      | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7703QDR       | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7703QDRG4     | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7703QP        | ACTIVE                | PDIP         | P               | 8    | 50          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| TLC7703QPE4      | ACTIVE                | PDIP         | P               | 8    | 50          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| TLC7703QPW       | ACTIVE                | TSSOP        | PW              | 8    | 150         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7703QPWG4     | ACTIVE                | TSSOP        | PW              | 8    | 150         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7703QPWR      | ACTIVE                | TSSOP        | PW              | 8    | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7703QPWRG4    | ACTIVE                | TSSOP        | PW              | 8    | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7705ID        | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7705IDG4      | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7705IDR       | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7705IDRG4     | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7705IP        | ACTIVE                | PDIP         | P               | 8    | 50          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| TLC7705IPE4      | ACTIVE                | PDIP         | P               | 8    | 50          | Pb-Free                 | CU NIPDAU        | N / A for Pkg Type           |

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| (RoHS)           |                       |              |                 |      |             |                         |                  |                              |
| TLC7705IPW       | ACTIVE                | TSSOP        | PW              | 8    | 150         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7705IPWG4     | ACTIVE                | TSSOP        | PW              | 8    | 150         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7705IPWLE     | OBSOLETE              | TSSOP        | PW              | 8    |             | TBD                     | Call TI          | Call TI                      |
| TLC7705IPWR      | ACTIVE                | TSSOP        | PW              | 8    | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7705IPWRG4    | ACTIVE                | TSSOP        | PW              | 8    | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7705MFKB      | ACTIVE                | LCCC         | FK              | 20   | 1           | TBD                     | POST-PLATE       | N / A for Pkg Type           |
| TLC7705MJG       | ACTIVE                | CDIP         | JG              | 8    | 1           | TBD                     | A42 SNPB         | N / A for Pkg Type           |
| TLC7705MJGB      | ACTIVE                | CDIP         | JG              | 8    | 1           | TBD                     | A42 SNPB         | N / A for Pkg Type           |
| TLC7705MUB       | ACTIVE                | CFP          | U               | 10   | 1           | TBD                     | A42 SNPB         | N / A for Pkg Type           |
| TLC7705QD        | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7705QDG4      | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7705QDR       | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7705QDRG4     | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7705QP        | ACTIVE                | PDIP         | P               | 8    | 50          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| TLC7705QPE4      | ACTIVE                | PDIP         | P               | 8    | 50          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| TLC7705QPW       | ACTIVE                | TSSOP        | PW              | 8    | 150         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7705QPWG4     | ACTIVE                | TSSOP        | PW              | 8    | 150         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7705QPWLE     | OBSOLETE              | TSSOP        | PW              | 8    |             | TBD                     | Call TI          | Call TI                      |
| TLC7705QPWR      | ACTIVE                | TSSOP        | PW              | 8    | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7705QPWRG4    | ACTIVE                | TSSOP        | PW              | 8    | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7725ID        | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7725IDG4      | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7725IDR       | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7725IDRG4     | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7725IP        | ACTIVE                | PDIP         | P               | 8    | 50          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| TLC7725IPE4      | ACTIVE                | PDIP         | P               | 8    | 50          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| TLC7725IPW       | ACTIVE                | TSSOP        | PW              | 8    | 150         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7725IPWG4     | ACTIVE                | TSSOP        | PW              | 8    | 150         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
|                  |                       |              |                 |      |             | no Sb/Br)               |                  |                              |
| TLC7725IPWLE     | OBSOLETE              | TSSOP        | PW              | 8    |             | TBD                     | Call TI          | Call TI                      |
| TLC7725IPWR      | ACTIVE                | TSSOP        | PW              | 8    | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7725IPWRG4    | ACTIVE                | TSSOP        | PW              | 8    | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7725QD        | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7725QDR       | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7725QDRG4     | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7725QP        | ACTIVE                | PDIP         | P               | 8    | 50          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| TLC7725QPE4      | ACTIVE                | PDIP         | P               | 8    | 50          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| TLC7725QPW       | ACTIVE                | TSSOP        | PW              | 8    | 150         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7725QPWG4     | ACTIVE                | TSSOP        | PW              | 8    | 150         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7725QPWLE     | OBSOLETE              | TSSOP        | PW              | 8    |             | TBD                     | Call TI          | Call TI                      |
| TLC7725QPWR      | ACTIVE                | TSSOP        | PW              | 8    | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7725QPWRG4    | ACTIVE                | TSSOP        | PW              | 8    | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7733ID        | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7733IDG4      | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7733IDR       | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7733IDRG4     | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7733IP        | ACTIVE                | PDIP         | P               | 8    | 50          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| TLC7733IPE4      | ACTIVE                | PDIP         | P               | 8    | 50          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| TLC7733IPW       | ACTIVE                | TSSOP        | PW              | 8    | 150         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7733IPWG4     | ACTIVE                | TSSOP        | PW              | 8    | 150         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7733IPWR      | ACTIVE                | TSSOP        | PW              | 8    | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7733IPWRG4    | ACTIVE                | TSSOP        | PW              | 8    | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7733MFKB      | ACTIVE                | LCCC         | FK              | 20   | 1           | TBD                     | POST-PLATE       | N / A for Pkg Type           |
| TLC7733MJG       | ACTIVE                | CDIP         | JG              | 8    | 1           | TBD                     | A42 SNPB         | N / A for Pkg Type           |
| TLC7733MJGB      | ACTIVE                | CDIP         | JG              | 8    | 1           | TBD                     | A42 SNPB         | N / A for Pkg Type           |
| TLC7733QD        | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| TLC7733QDG4      | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7733QDR       | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7733QDRG4     | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7733QP        | ACTIVE                | PDIP         | P               | 8    | 50          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| TLC7733QPE4      | ACTIVE                | PDIP         | P               | 8    | 50          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| TLC7733QPW       | ACTIVE                | TSSOP        | PW              | 8    | 150         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7733QPWG4     | ACTIVE                | TSSOP        | PW              | 8    | 150         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7733QPWR      | ACTIVE                | TSSOP        | PW              | 8    | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TLC7733QPWRG4    | ACTIVE                | TSSOP        | PW              | 8    | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSELETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

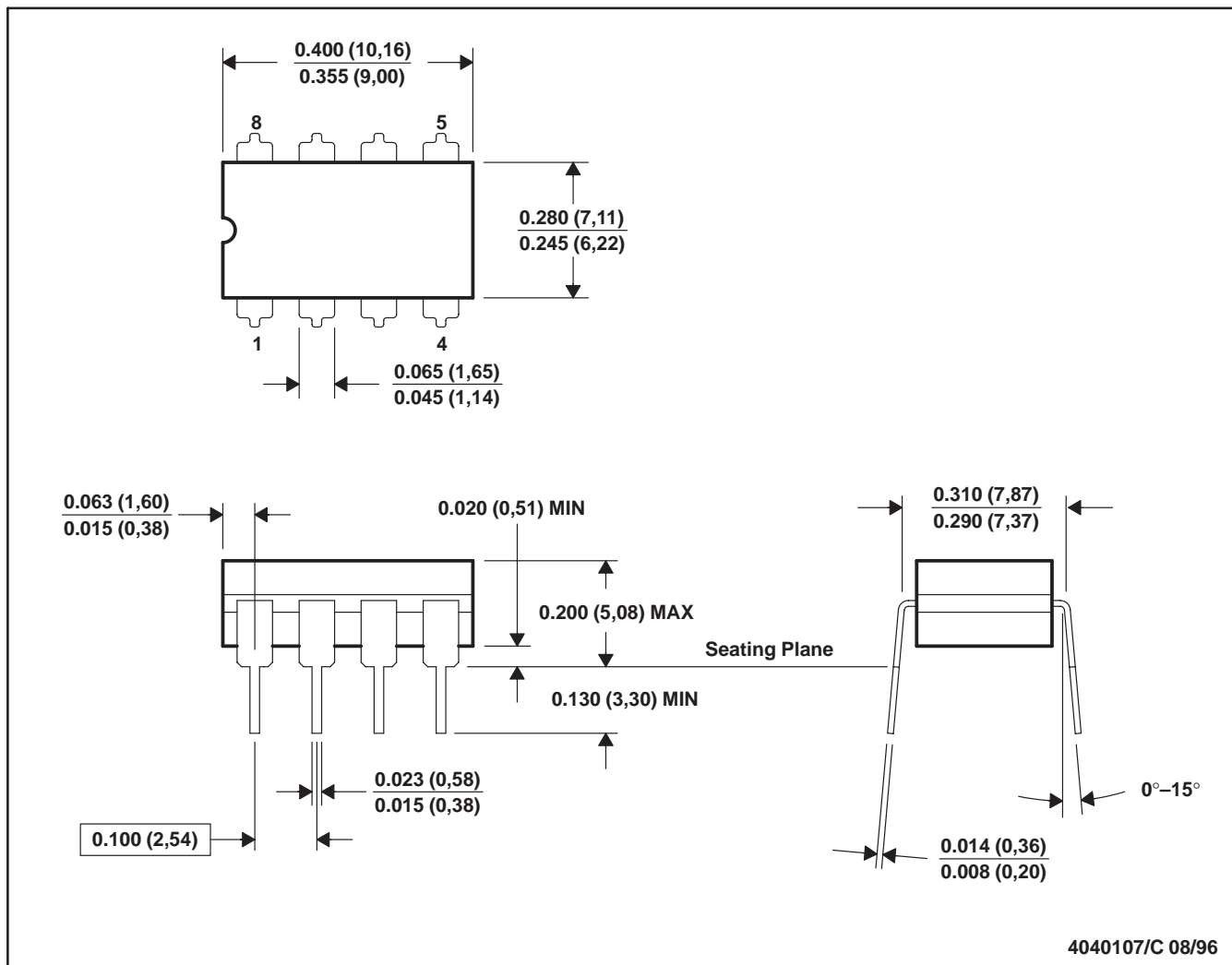
<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

**Important Information and Disclaimer:**The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

JG (R-GDIP-T8)

CERAMIC DUAL-IN-LINE

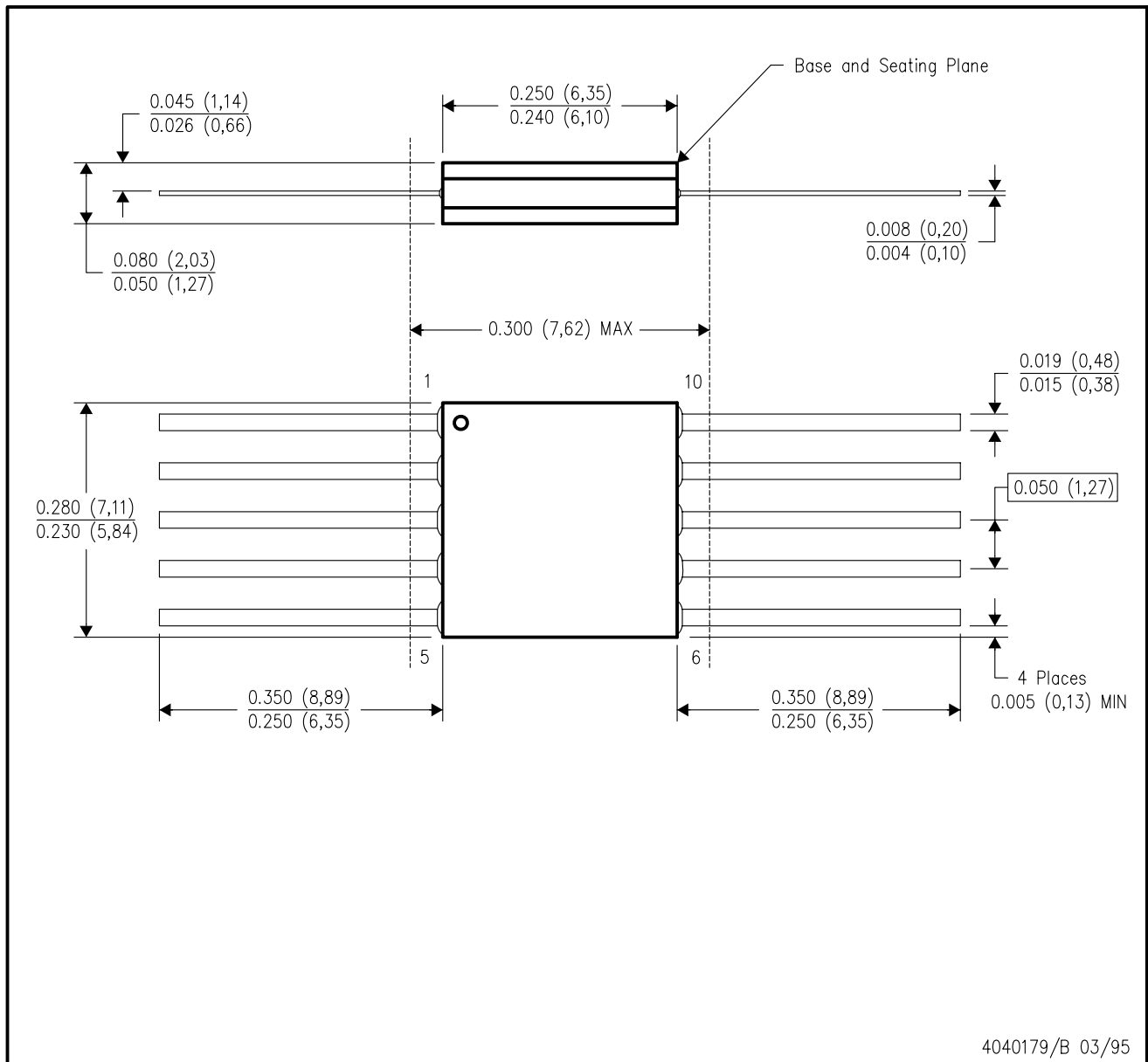


- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. This package can be hermetically sealed with a ceramic lid using glass frit.  
 D. Index point is provided on cap for terminal identification.  
 E. Falls within MIL STD 1835 GDIP1-T8



U (S-GDFP-F10)

CERAMIC DUAL FLATPACK



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only.
  - E. Falls within MIL STD 1835 GDFP1-F10 and JEDEC MO-092AA

FK (S-CQCC-N\*\*)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a metal lid.
  - D. The terminals are gold plated.
  - E. Falls within JEDEC MS-004

P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE



4040082/D 05/98

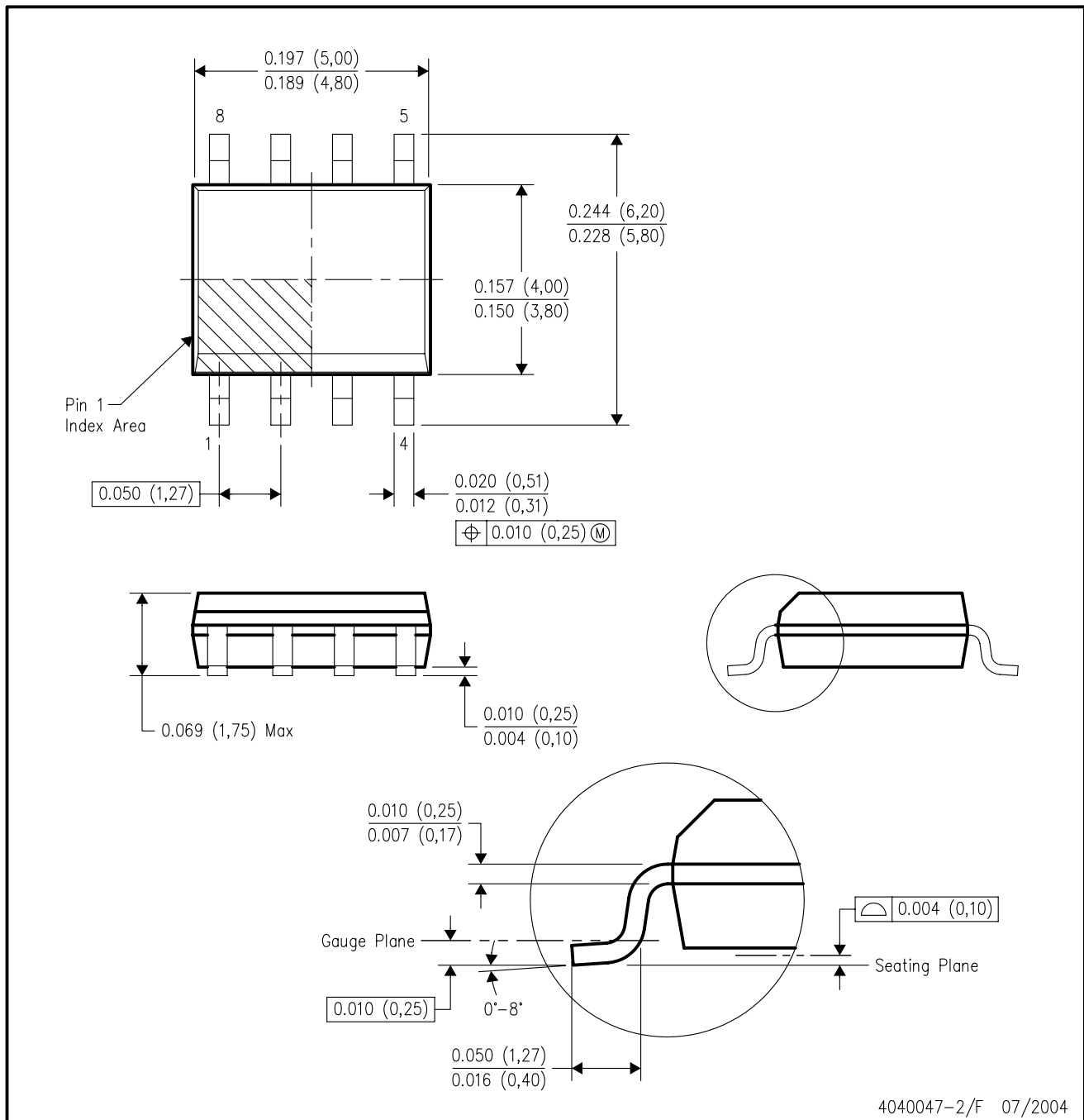
- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. Falls within JEDEC MS-001

For the latest package information, go to [http://www.ti.com/sc/docs/package/pkg\\_info.htm](http://www.ti.com/sc/docs/package/pkg_info.htm)



D (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
  - D. Falls within JEDEC MS-012 variation AA.

PW (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



4040064/F 01/97

- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

## IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

| <b>Products</b>    |  | <b>Applications</b> |  |
|--------------------|--|---------------------|--|
| Amplifiers         | <a href="http://amplifier.ti.com">amplifier.ti.com</a>             | Audio               | <a href="http://www.ti.com/audio">www.ti.com/audio</a>                   |
| Data Converters    | <a href="http://dataconverter.ti.com">dataconverter.ti.com</a>     | Automotive          | <a href="http://www.ti.com/automotive">www.ti.com/automotive</a>         |
| DSP                | <a href="http://dsp.ti.com">dsp.ti.com</a>                         | Broadband           | <a href="http://www.ti.com/broadband">www.ti.com/broadband</a>           |
| Interface          | <a href="http://interface.ti.com">interface.ti.com</a>             | Digital Control     | <a href="http://www.ti.com/digitalcontrol">www.ti.com/digitalcontrol</a> |
| Logic              | <a href="http://logic.ti.com">logic.ti.com</a>                     | Military            | <a href="http://www.ti.com/military">www.ti.com/military</a>             |
| Power Mgmt         | <a href="http://power.ti.com">power.ti.com</a>                     | Optical Networking  | <a href="http://www.ti.com/opticalnetwork">www.ti.com/opticalnetwork</a> |
| Microcontrollers   | <a href="http://microcontroller.ti.com">microcontroller.ti.com</a> | Security            | <a href="http://www.ti.com/security">www.ti.com/security</a>             |
| Low Power Wireless | <a href="http://www.ti.com/lpw">www.ti.com/lpw</a>                 | Telephony           | <a href="http://www.ti.com/telephony">www.ti.com/telephony</a>           |
|                    |  | Video & Imaging     | <a href="http://www.ti.com/video">www.ti.com/video</a>                   |
|                    |  | Wireless            | <a href="http://www.ti.com/wireless">www.ti.com/wireless</a>             |

Mailing Address: Texas Instruments  
Post Office Box 655303 Dallas, Texas 75265